

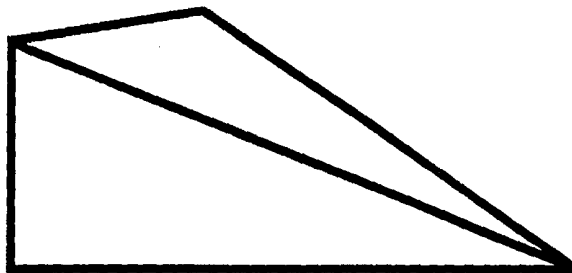


## INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

<b>(51) International Patent Classification <sup>7</sup> :</b>  <b>G01R 33/09</b>	<b>A1</b>	<b>(11) International Publication Number:</b> <b>WO 00/40987</b>  <b>(43) International Publication Date:</b> 13 July 2000 (13.07.00)
<b>(21) International Application Number:</b> PCT/SE99/02303  <b>(22) International Filing Date:</b> 9 December 1999 (09.12.99)  <b>(30) Priority Data:</b> 9900015-0                      7 January 1999 (07.01.99)                      SE  <b>(71) Applicant (for all designated States except US):</b> FORSKARPATENT I UPPSALA AB [SE/SE]; Uppsala Science Park, S-751 83 Uppsala (SE).  <b>(72) Inventor; and</b> <b>(75) Inventor/Applicant (for US only):</b> WÄPPLING, Roger [SE/SE]; Furudalsvägen 16, S-752 60 Uppsala (SE).  <b>(74) Agents:</b> HEDBERG, Åke et al.; Aros Patent AB, P.O. Box 1544, S-751 45 Uppsala (SE).		<b>(81) Designated States:</b> AE, AL, AM, AT, AT (Utility model), AU, AZ, BA, BB, BG, BR, BY, CA, CH, CN, CR, CU, CZ, CZ (Utility model), DE, DE (Utility model), DK, DK (Utility model), DM, EE, EE (Utility model), ES, FI, FI (Utility model), GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KR (Utility model), KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, SK (Utility model), SL, TJ, TM, TR, TT, TZ, UA, UG, US, UZ, VN, YU, ZA, ZW, ARIPO patent (GH, GM, KE, LS, MW, SD, SL, SZ, TZ, UG, ZW), Eurasian patent (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE), OAPI patent (BF, BJ, CF, CG, CI, CM, GA, GN, GW, ML, MR, NE, SN, TD, TG).  <b>Published</b> <i>With international search report.</i> <i>Before the expiration of the time limit for amending the claims and to be republished in the event of the receipt of amendments.</i>

**(54) Title:** UTILIZATION OF A MAGNETO-RESISTIVE MATERIAL**(57) Abstract**

The present invention discloses a device, which forms a position sensor for non-contact position measurement. The position sensor comprises a sensor magnet and a sensor body. The sensor body is then formed from a magneto-resistive material and is given a two or three dimensional geometrical shape to achieve a desired sensitivity function. Thus, the desired sensitivity function results from a variation in one or more of the sensor body dimensions. By forming the sensor body of magneto-resistive material into different geometrical shapes like a simple wedge, a double wedge, a circular tapered form or an arbitrary shape, a desired sensitivity function is obtained.



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**Utilization of a magneto-resistive material****TECHNICAL FIELD**

5 The present invention relates to tailoring the shape of a magneto-resistive material, and more particularly to a design of the shape of the magneto-resistive material to obtain a new type of position sensitive sensor.

**BACKGROUND**

10 The position of a moving object is often determined by means of the readout from a resistive sensor, usually of potentiometer type, which is mechanically connected to the object to be monitored.

15 In order to reduce the wear and thereby increase the reliability, it is desirable to eliminate the sliding friction encountered in the standard resistive sensors. Non-contact methods using e.g. inductively coupled coils is currently being introduced as replacement for the potentiometer sensors. However, these are more complex and therefore more expensive.

20 In recent years novel types of magneto-resistive materials with much higher sensitivity to moderate changes in magnetic fields have been found. These new materials showing giant magneto-resistance (GMR) or colossal magneto-resistance (CMR) make possible new types of position sensors.

25 In a document U.S. Patent No. 5,475,304 is disclosed a giant magneto-resistant sensor including at least one layered structure. The layered structure includes a ferromagnetic layer having a fixed magnetic state, a second, softer magnetic layer, and a metal layer interposed between and contacting these two layers. The sensor also includes one or more indexing magnets for inducing a domain wall, at a measured position, between  
30 regions of nonaligned magnetic fields in the softer magnetic layer. By measuring the resistance across the magneto-resistant sensor a displacement of one workpiece, carrying the sensor, will be measured relative to another workpiece carrying an inducing means.

Yet another document U.S. Patent No. 5,627,466 discloses a position measuring device having a sensor, the output signal of which is a function of the distance between a graduation and a scanning unit. Magneto-resistive elements, which scan the graduation, are disposed in the active branch of a potentiometer circuit. The voltage over the active branch is taken as the distance-dependent signal and is used to control the amplitude of the position-dependent scanning signals generated by scanning the graduation.

However, there is still a demand for non-contact sensor devices for position measurement offering a sensitivity function adapted to the particular application.

### SUMMARY

The object of present invention is to disclose a device, which forms a position sensor for non-contact position measurement. The device comprises a sensor magnet and a sensor body made of a magneto-resistive material, whereby the magneto-resistive material is formed into a body having two or three dimensional geometrical shape to achieve a desired sensitivity function. The desired sensitivity function then results from a variation in one or more of the sensor body dimensions.

According to the object of the present invention the sensor body presents in different embodiments shapes like a simple wedge, a double wedge, a circular tapered form or an arbitrary shape to obtain the desired sensitivity function.

The sensor device according to the present invention is set forth by the attached independent claim 1 and further embodiments are set forth by the dependent claims 2 - 7.

## BRIEF DESCRIPTION OF THE DRAWINGS

The invention, together with further objects and advantages thereof, may best be understood by making reference to the following description taken together with the accompanying drawings, in which:

FIG. 1 illustrates a basic circuit diagram for measuring the change of the resistance in a position sensitive sensor made in a magneto-resistive material;

FIG. 2 illustrates an embodiment with a basic wedge shape for a position sensitive sensor made from a magneto-resistive material;

FIG. 3 illustrates an embodiment having a double wedge shape for a position sensitive sensor made from a magneto-resistive material;

FIG. 4 illustrates an embodiment having a circular shape for a position sensitive sensor made from a magneto-resistive material; and

FIG. 5 illustrates an embodiment having an arbitrary shape for a position sensitive sensor made from a magneto-resistive material

## DETAILED DESCRIPTION

Theory

The electric resistance of a segment of length  $\Delta l$  and an average area  $A$  made up of a material with resistivity  $\rho$  is given by

$$\Delta R = \rho \frac{\Delta l}{A}$$

If a magnetic field is applied over this segment the resistance changes by the amount

$$\delta \Delta R = \delta \rho \frac{\Delta l}{A}$$

the magnitude of this change depends on the material in question and is for GMR materials typically some tens of percent while for CMR much higher values can be obtained in limited temperature ranges. For a conductor of constant cross-section the change is independent of position but if A is a function of position, unique position information can be obtained. The above described sensitivity to position is utilized for instance in a Wheatstone type bridge circuitry consisting of two identical standard resistors R and one (or two) magneto-resistive elements  $R_1$  and  $R_x = R_1 - \delta\Delta R$ . If one of the magneto-resistive strips is exposed to a magnetic field over the distance  $\Delta l$  at position x, the resistance of this strip changes by

$$\delta\Delta R = \delta\rho \frac{\Delta l}{A(x)}$$

as a consequence, the voltage between the connecting points A and B,  $V_{AB}$ , changes from an initial value of zero to

$$V_{AB} = -\frac{E}{4} \frac{\delta\Delta R}{R - \delta\Delta R}$$

For small  $\delta\Delta R$  this changes to

$$V_{AB} = -\frac{E}{4} \frac{\delta\Delta R}{R}$$

and the voltage difference is then directly related to the position.

$$V_{AB} = -\frac{E}{4R} \delta\rho \frac{\Delta l}{A(x)}$$

## Description of an illustrative embodiment

In an illustrative embodiment for a GMR-based system the magneto-resistive material consists of a Co/Cu multi-layer prepared by sputtering on a glass or silicon substrate with a thickness of the layers of the order of 1 nm and chosen such that an anti-ferromagnetic ordering is obtained between consecutive magnetic layers. The number of repetitions is some tens and the multi-layer structure is protected by a 1 nm thick coating layer of tantalum. This material is formed in the appropriate shape to achieve the desired sensitivity function either by masking during deposition or by cutting or

etching after deposition. The sensitivity function is the result of a variation of one or two dimensions as displayed for a different geometry in Figs. 2 - 5.

The obtained magneto-resistive material (the sensing element) is mounted fixed onto a holder and a small moving permanent magnet, rigidly connected to the moving object, the position of which is to be determined, is positioned close to the sensing element so that part of the sensor material is exposed to the magnetic field. The magnitude of the field from the permanent magnet is sufficiently large so that the exposed part of the sensing element is driven into the ferromagnetic state resulting in a (local) resistance change of the order of 20-50%. This change in resistance is measured directly or through the resulting asymmetry in a Wheatstone type bridge.

Fig. 1 illustrates a typical circuit diagram forming a bridge for measuring the change in resistance of a position sensor element 1 utilizing a magneto-resistive material. The sensor element 1 of a resistance  $R_x$  and a resistor 4 having a fixed value  $R$  form a first branch and a resistor 2 having a fixed value  $R_1$  and a resistor 3 having the fixed value  $R$  constitute the second branch of the bridge. The resistance  $R_1$  corresponds to the nominal resistance of the sensor element 1 and preferably having a temperature dependency corresponding to the temperature dependency of the sensor element 1. In a typical embodiment a permanent magnet 5 is placed close to the sensor element 1 such that the magnet and the element 1 may be displaced in relation to each other in a  $x$ -direction indicated by the double arrow. One terminal of a voltmeter 6 is connected to the connection point between  $R_x$  and  $R_1$ . The other terminal of the voltmeter 6 is connected to the connection point between resistors 3 and 4. The voltmeter measures voltage differences achieved by the two voltage dividers formed by the two branches, which are supplied by a voltage source  $E$ . Thus, a change in the voltage difference displayed by the voltmeter 6 will be a function of a variation of the resistance 1, which in turn is a function of a motion  $x$  of the magnet 5.

$$R_x = R_1 - \partial R ; \partial R = f(x) \Rightarrow V = V(x)$$

5 The area where the magnetic field acts is indicated by the reference numeral 5 in Fig. 1. The element R1 and Rx may even be made as identical elements. However in most cases R1 will be replaced by a suitable standard metal film resistor. Furthermore the shape of the sensor material is varied to accommodate the specific sensitivity function desired.

10 Consequently the magneto-resistive material is formed into an arbitrary shape to achieve the desired sensitivity function. The sensitivity function may primarily be the result of a variation in one dimension, e.g. the width of a strip of material as visualized by the form of Rx in Fig. 1. This is then accomplished by using a any type of magneto-resistive material where the constant  
15 thickness represents a multi layer structure having the thickness of the layer chosen such that an anti-ferromagnetic ordering is obtained between consecutive magnetic layers.

20 According to the present improvement two dimensions are varied, as is displayed in Fig 2 and 3, where the number of repetition layers is varied, still preserving the anti-ferromagnetic ordering, so that a stepwise change is superimposed on the signal corresponding to the simple wedge demonstrated in Fig. 2.

25 In Fig. 4 and 5 further embodiments of the position sensitive sensor are displayed. A small moving magnet, rigidly connected to the moving object the position of which is to be determined, is positioned close to the magneto-resistive material so that part of the magneto-resistive material is exposed to the field and driven into the ferromagnetic state resulting in a resistance  
30 change.



It will be understood by those skilled in the art that various modifications and changes may be made to the present invention without departure from the scope thereof, which is defined by the appended claims.

## CLAIMS

1. A device forming a position sensor for non-contact position measurement comprising a sensor magnet and a sensor body made of a magneto-resistive material, **characterized in** that the magneto-resistive material is formed into a two or three dimensional geometrical shape to achieve a desired sensitivity function, whereby the sensitivity function will be the result of a variation in one or more of the sensor body dimensions.

2. The device according to claim 1, **characterized in** that a small moving magnet, rigidly connected to the moving object the position of which is to be determined, is positioned close to the magneto-resistive sensor body such that that only a defined part of the magneto-resistive material is exposed to the field and driven into a ferromagnetic state resulting in a resistance change to be measured.

3. The device according to claim 2, **characterized in** that the material of the sensor body is a magneto-resistive material in which a constant thickness, in the utilization of a GMR material, represents a multi-layer with a thickness of the layers chosen such that an anti-ferromagnetic ordering is obtained between consecutive magnetic layers.

4. The device according to claim 2, **characterized in** that the material of the sensor body is a simple wedge and is a magneto-resistive material in which one dimension, in the case of a GMR material perpendicular to the stacking direction, is varied.

5. The device according to claim 2, **characterized in** that the material of the sensor body is a double wedge and is magneto-resistive material in which, for a GMR material, the number of repetitions is varied so that a stepwise change is superimposed on the signal corresponding to the simple wedge.

6. The device according to claim 2, **characterized in** that the material of the sensor body is a magneto-resistive material formed in a circular tapered form.

5 7. The device according to claim 2, **characterized in** that the material of the sensor body has an arbitrary form and is a magneto-resistive material giving a signal corresponding to the form of the sensor body,

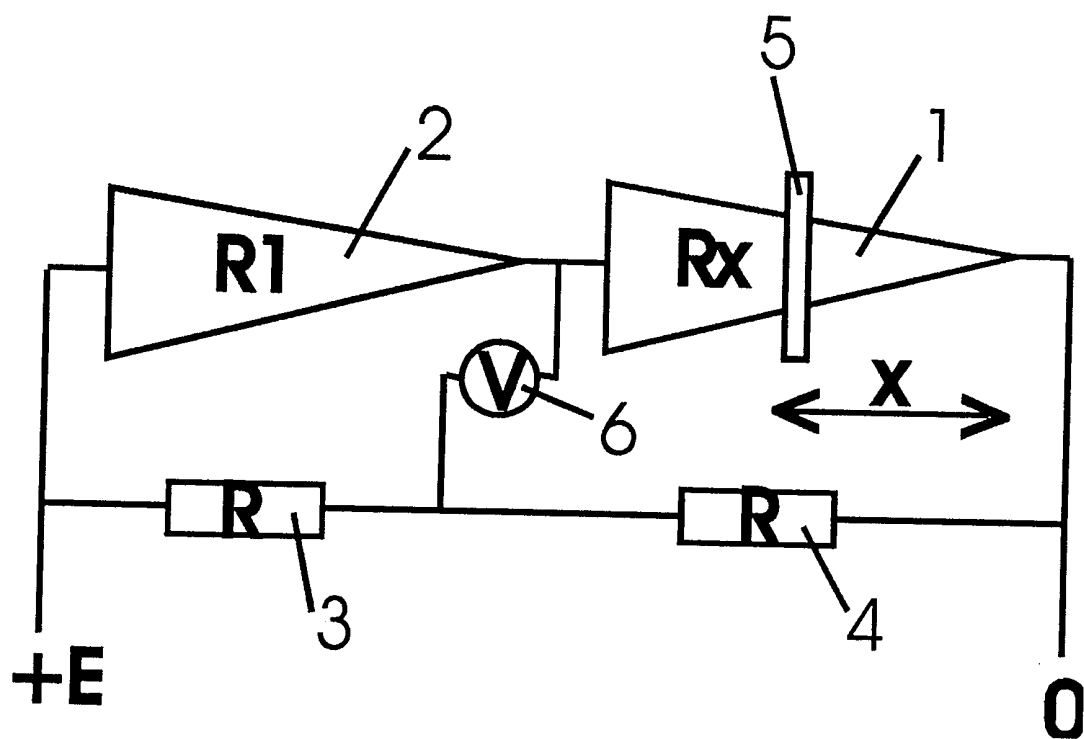


Fig. 1

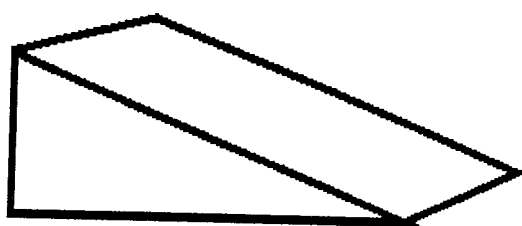


Fig. 2

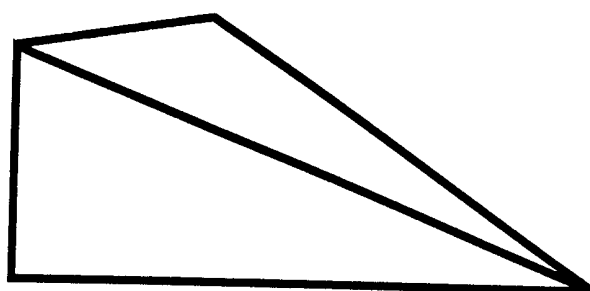


Fig. 3

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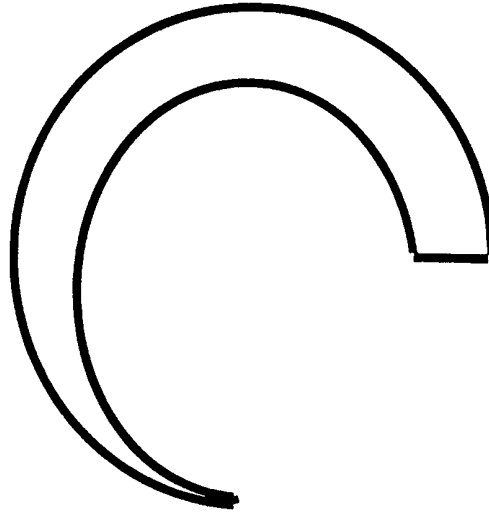


Fig. 4

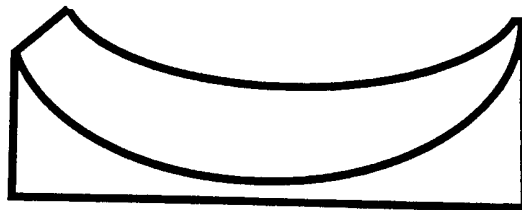


Fig. 5

# INTERNATIONAL SEARCH REPORT

International application No.  
PCT/SE 99/02303

## A. CLASSIFICATION OF SUBJECT MATTER

IPC7: G01R 33/09  
According to International Patent Classification (IPC) or to both national classification and IPC

## B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC7: G01B, G01D, G01R, H01L

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched  
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## C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
P,A	EP 0921407 A2 (SONY PRECISION TECHNOLOGY INC.), 9 June 1999 (09.06.99), figures 14,15, abstract --	1-7
A	US 5351027 A (S. KAWAMATA ET AL), 27 Sept 1994 (27.09.94), abstract --	1-7
A	US 5627466 A (A. SPIES ET AL), 6 May 1997 (06.05.97), abstract --	1-7
A	US 5475304 A (G.A. PRINZ), 12 December 1995 (12.12.95), abstract --	1-7

☒ Further documents are listed in the continuation of Box C. ☒ See patent family annex.

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International application No.  
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C (Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	WO 9514213 A1 (EISSCHIEL, HEINZ ET AL), 26 May 1995 (26.05.95), figure 1, abstract  -- -----	1-7



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Information on patent family members

International application No.

PCT/SE 99/02303

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